



QUALITY ASSURANCE DEPARTMENT MICRO-SECTIONING REPORT

P OF

CUSTOMER: _____ CUST. P/N: _____
 P/N: _____ DATE CODE: _____ REF. NO: _____

PURPOSE: FIRST ARTICLE

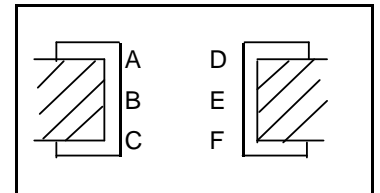
TEST METHOD: IPC-TM-650 2.1.1

APPARATUS: MICROSCOPE: 40x 100x 200x 400x

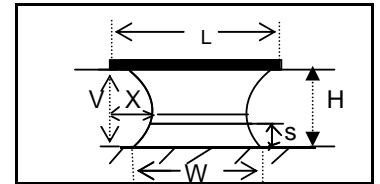
REQUIREMENT: Thickness unit: um V/X: Etch Factor \geq 1.0

Base Cu THK	PTH Copper	Conductor THK	Nickel	Solder Mask	Solder Coating

NO	Symbol	A	B	C	D	E	F	AVE
	Cu							
2								
3								
4								
5								



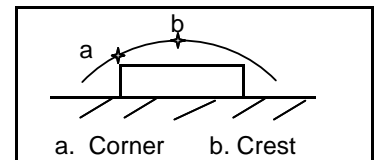
CONDUCTOR THK BASE CU THK SOLDER MASK THK TIN THK
 H: _____ a: _____
 _____ b: _____



V/X: _____ LINE WIDTH L: _____ W: _____

COMMENT: H=FINISHED CU THK a.b=SOLDER MASK THK
S=BASE CU THK

DISPOSITION: ACC REJ



PREPARED BY: _____ DATE: _____

APPROVED BY: _____ DATE: _____

QA-021-05C